DIAMOND SERIES



DIAMOND H3 WAFER HANDLING ROBOTS



The Diamond H₃ series atmospheric robots represent a significant engineering advancement in the design and reliability of wafer handling equipment.

Benefiting from technologically superior components, the robots utilize ultra low inertia, high-response brushless servomotors coupled with zero-backlash Harmonic Drive® gears to achieve greatly enhanced dexterity and precision.

The innovative, all-in-one, class 1 clean room compatible design incorporates the motion controller, servo amplifiers, and power supply within the robot's industry standard footprint.

High-strength structural members enable top, bottom or side mount configurations without compromising the system rigidity.

A 32-bit, real-time kernel delivers accurate motion profiling along smooth continuous trajectories, while the distributed control architecture allows a seamless integration with linear tracks, prealigners, and other sub-components.

Networkable RS-485 and Ethernet interfaces complement the standard RS-232 and teach pendant connections. Powerful native wafer handling and scripting languages facilitate rapid software development for embedding the robots into an OEM application environment. Comprehensive emulation of legacy robot "macro" commands offers a drop-in compatibility with a wide variety of existing semiconductor tools.

FEATURES

- Excellent structural rigidity
- Modular and highly customizable design
- Arm length from 10.50" up to 24.00"
- Vertical travel up to 21"
- Fully integrated motion controller, servo amplifiers and power supply
- High response brushless motors and precise zero-backlash Harmonic Drive[®] gears
- Optional absolute encoders eliminating the initial homing procedure
- Handling radial and in-line equipment placement
- Seamless integration with prealigner, linear track and other peripheral components
- Standard RS-232 interface and Ethernet (Telnet) interfaces to the host computer
- Advance 32-bit real-time motion control kernel
- Powerful wafer handling firmware
- Comprehensive software tools and utilities
- Software emulation for legacy robot macro commands
- Optional teach pendant terminal
- General purpose digital inputs and outputs for custom use
- Class 1 clean-room environment compatibility
- Reliability MTBF > 60,000 hours, (MCBF > 10,000,000 cycles)

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DIAMOND H3 DATA SHEET

Axis	Motion range	Maximum velocity	Maximum acceleration	Axis Repeatability
Т	> 360° (typical +/-230°)	360 °/s	1500 °/s²	±0.01°
R	From ± 10.5 " Up to ± 17.0 " (depending on arm)	Up to 50 inch/s (depending on arm size)	300 inch/s ²	±0.001" (0025mm)
Z	From 13" up to 21" (depending on robot body model)	18 inch/s	44 inch/s ²	±0.001" (0025mm)



WAFER SIZE 2"(50mm) to 12"(300mm)

PAYLOAD

2.2 lbs (1.0 kg)

ENCODERS Incremental, 10.000 pulse/rev

MOTOR TYPE

Brushless, low inertia high responce

WEIGHT

62 lbs (28 kg) for 13" vert. travel, and 7.2"x7.2" arm

DPERATING TEMPERATURES 50°F-104°F (10°C to 40°C)

FACILITY REQUIREMENTS

Voltage range 100-120AVC, 200-240VAC Vacuum supply 11.8" Hg(-5.8psi) / 0.1CFM airflow





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